

Title (en)
SYSTEM AND METHOD FOR THE STERILE PACKAGING OF PRODUCTS

Title (de)
ANLAGE SOWIE VERFAHREN ZUM STERILEN VERPACKEN VON PRODUKTEN

Title (fr)
INSTALLATION ET PROCEDE D'EMBALLAGE STERILE DE PRODUITS

Publication
EP 2132096 B1 20120222 (DE)

Application
EP 08716545 A 20080314

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• EP 2008002050 W 20080314
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Abstract (en)
[origin: US2010077701A1] The present application relates to a method and apparatus for preparing and filling packages including pouches and containers, such as pouches and containers for food stuff. The abstract of the disclosure is submitted herewith as required by 37 C.F.R. §1.72(b). As stated in 37 C.F.R. §1.72(b): A brief abstract of the technical disclosure in the specification must commence on a separate sheet, preferably following the claims, under the heading "Abstract of the Disclosure." The purpose of the abstract is to enable the Patent and Trademark Office and the public generally to determine quickly from a cursory inspection the nature and gist of the technical disclosure. The abstract shall not be used for interpreting the scope of the claims. Therefore, any statements made relating to the abstract are not intended to limit the claims in any manner and should not be interpreted as limiting the claims in any manner.

IPC 8 full level
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CPC (source: EP US)
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Cited by
CN107029262A

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DOCDB simple family (publication)
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